2. The display device of claim 1, wherein at least a portion of the fixing member disposed to cover a light emitting surface of the display panel is transparent.

3. The display device of claim 1, wherein the fixing member comprises:

a first portion disposed to cover a first surface of the display panel; and

a second portion disposed to cover a second surface of the display panel, the second surface being opposite the first surface,

wherein the first portion and the second portion of the fixing member are sealed outside of a periphery of the display panel by thermal compression.

4. The display device of claim 3, wherein the thicknesses of each of the first and second portions of the fixing member is less than 0.6 mm.

5. The display device of claim 1, wherein the fixing member is made of plastic, silicon, and/or a polarizing film.

6. The display device of claim 1, wherein the display panel comprises:

a substrate and an encapsulation substrate disposed to face each other, the substrate including an extension portion that extends beyond an edge of the encapsulation substrate; and

a flexible printed circuit board disposed on the extension portion.

7. The display device of claim 6, further comprising:

an integrated circuit chip disposed on the extension portion,

wherein the flexible circuit board is electrically connected to the integrated circuit chip and extends from the substrate.

8. The display device of claim 6, wherein the fixing member surrounds at least a portion of the flexible printed circuit board.

9. The display device of claim 3, further comprising:

a flexible printed circuit board electrically connected to the display panel and extending therefrom between the first and second portions of the fixing member.

10. The display device of claim 9, wherein the first and second portions of the fixing member are sealed about the flexible printed circuit board.

11. The display device of claim 1, further comprising:

an organic light emitting element disposed between the substrate and the encapsulation substrate; and

a sealing member disposed between the substrate and the encapsulation substrate to seal the organic light emitting element therein.

12. An organic light emitting diode (OLED) display, comprising:

a panel assembly having a display area; and

a fixing member, the fixing member being disposed to cover at least a portion of each surface of the panel assembly.

13. The OLED display of claim 12, wherein the panel assembly has a hexahedral shape, and the fixing member covers at least a portion each of the six surfaces of the panel assembly.

14. The OLED display of claim 12, wherein the fixing member comprises:

a first cover portion disposed to cover a rear surface of the panel assembly;

four second cover portions respectively corresponding to the side surfaces of the panel assembly; and

a third cover portion corresponding to the front surface of the panel assembly.

15. The OLED display of claim 14, wherein each of the second cover portions is bent from the first cover unit toward the front surface of the panel assembly, and the third cover portion is bent from one of the second cover portions to cover the front surface of the panel assembly.

16. The OLED display of claim 14, wherein the panel assembly comprises:

a pad area,

wherein one of the second cover portions, which corresponds to a side of the display panel adjacent to the pad area, includes an opening to expose a portion of the side of the display panel adjacent to the pad area.

17. The OLED display of claim 12, wherein the fixing member comprises:

a polarization layer, and

an adhesive layer disposed on one side of the polarization layer.

18. The OLED display of claim 17, wherein the adhesive layer adheres the fixing member the display panel.

19. The OLED display of claim 12, further comprising:

a pad area;

a flexible printed circuit board connected to the pad area; and

a printed circuit board electrically connected to the flexible printed circuit board,

wherein the printed circuit board is disposed on an outer surface of a portion of the fixing member disposed to cover the rear surface of the panel assembly.

20. The OLED display of claim 12, comprising:

a case disposed on a rear surface of the panel assembly that is covered by the fixing member; and

a double-sided tape disposed between the fixing member and the case.

21. The OLED display of claim 20, further comprising:

a pad area;

a flexible printed circuit board that is connected to the pad area; and

a printed circuit board that is electrically connected to the flexible printed circuit board,

wherein the printed circuit board is disposed on between the panel assembly and the case.

22. A method for manufacturing an organic light emitting diode (OLED) display, comprising:

preparing a panel assembly having a display area and a pad area;

mounting a flexible printed circuit board on the pad area, the flexible circuit board being connected to a printed circuit board;

preparing a fixing member to have a size capable of covering an external surface of the panel assembly; and

covering the panel assembly with the fixing member.

23. The method of claim 22, wherein the preparing of the fixing member comprises:

cutting a polarizing sheet to include a first cover portion corresponding to a rear surface of the panel assembly, four of second cover portions respectively corresponding to side surfaces of the panel assembly, and a third cover portion corresponding to a front surface of the panel assembly.

24. The method of claim 23, wherein the covering of the panel assembly with the fixing member comprises: